Thermoelectric Coolers for Reagent Storage

Thermoelectric Coolers for Handheld Cosmetic Lasers

Ceramic Plate Series Thermoelectric Cooler

The CP10-127-05-L1-EP-W4.5 is a high-performance and highly reliable standard Thermoelectric Cooler. Assembled with Bismuth Telluride semiconductor material and thermally conductive Aluminum Oxide ceramics. It has a maximum Qc of 33 Watts when $\Delta T=0$ and a maximum ΔT of 70.5 °C at Qc = 0.

Features

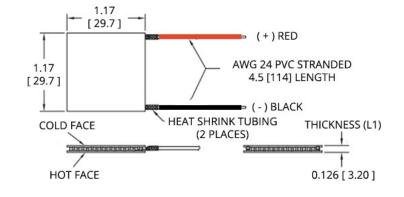
- Compact geometric sizes
- DC Operation
- RoHS-compliant
 - nt
- Cooling for CentrifugesHeads-Up Displays, Imaging Sensors

Applications

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Peltier Cooling for Machine Vision

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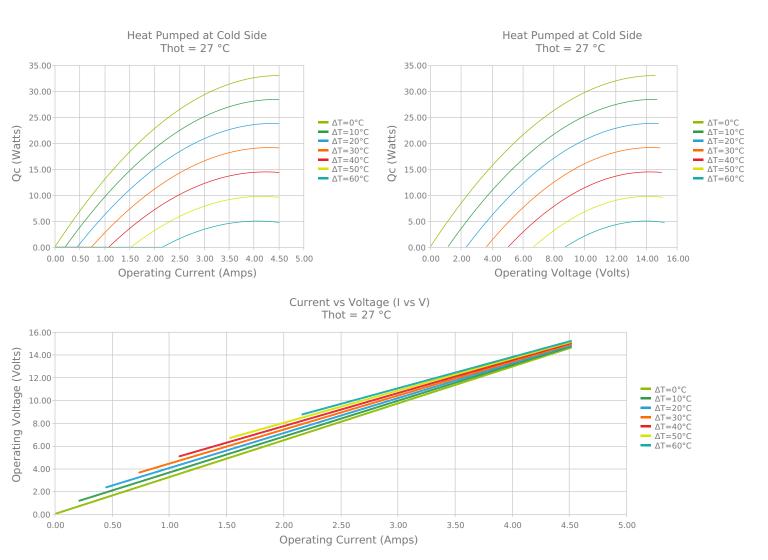


Ceramic Material: Alumina (Al₂O₃) Solder Construction: 138°C, Bismuth Tin (BiSn)

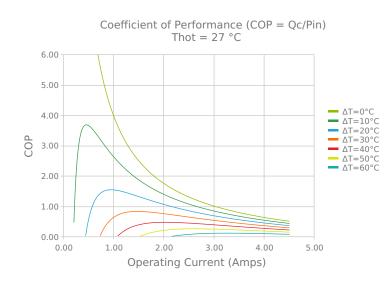
INCHES [MM]

Note: Allow 0.020 in [0.5 mm] around perimeter of the thermoelectric cooler and lead wire attachment to accommodate sealant

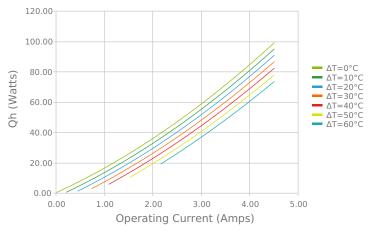
ELECTRICAL AND THERMAL PERFORMANCE

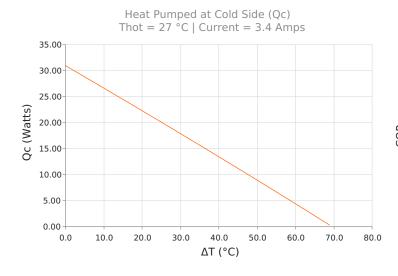


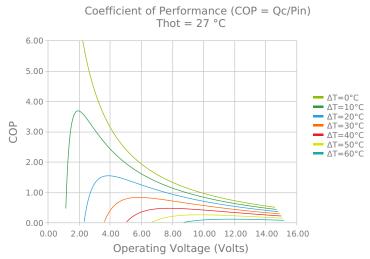
Laird







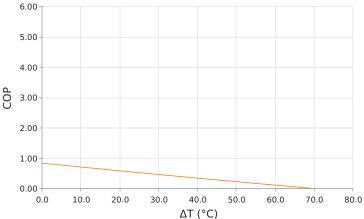




Total Heat Dissipated at Hot Side (Qh=Qc+Pin) Thot = 27 $^{\circ}C$



Coefficient of Performance (COP = Qc/Pin) Thot = 27 °C | Current = 3.4 Amps



SPECIFICATIONS*

Hot Side Temperature	27.0 °C	35.0 °C	50.0 °C
$Qcmax (\Delta T = 0)$	33.0 Watts	34.0 Watts	35.8 Watts
$\Delta Tmax (Qc = 0)$	70.5°C	73.5°C	78.8°C
lmax (I @ ΔTmax)	4.0 Amps	4.0 Amps	3.9 Amps
Vmax (V @ ΔTmax)	13.9 Volts	14.4 Volts	15.4 Volts
Module Resistance	3.24 Ohms	3.37 Ohms	3.62 Ohms
Max Operating Temperature	80 °C		
Weight	9.0 gram(s)		

* Specifications reflect thermoelectric coefficients updated March 2020

FINISHING OPTIONS

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
L1	$3.200 \pm 0.025 \text{ mm}$ $0.126 \pm 0.001 \text{ in}$	0.025 mm / 0.025 mm 0.001 in / 0.001 in	Lapped	Lapped	114.3 mm 4.50 in

SEALING OPTIONS

Suffix	Sealant	Color	Temp Range	Description
EP	Ероху	Black	-55 to 150°C	Low density syntactic foam epoxy encapsulant

NOTES

- 1. Max operating temperature: 80°C
- 2. Do not exceed Imax or Vmax when operating module
- 3. Reference assembly guidelines for recommended installation
- 4. Solder tinning also available on metallized ceramics

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